Ş	SPECIFICATIONS				
CUSTOMER	: PTC				
SAMPLE CODE	: SH480272	T015-IAC			
MASS PRODUCTION CODE	: PH480272	PH480272T015-IAC			
SAMPLE VERSION	: 01	01			
SPECIFICATIONS EDITION	: 001				
DRAWING NO. (Ver.)	: JLMD-PH4	80272T015-IAC_001			
PACKAGING NO. (Ver.)	:				
		Date:			
Approved	Checked	Designer			
閆偉	劉進	任健			
■ Preliminary specification for Specification for sample app					
☐ Specification for sample app		RP.			



History of Version

Date	Ver.	Edi.	Description	Page	Design by
08/22/2019	01	001	New Drawing.	-	任健
					- >
				-	

Total: 37 Page



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- 1.2 Mechanical Specifications
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Appendix: 1.LCM Drawing

Note: For detailed information please refer to IC data sheet: Sitronix --- ST7282-G4



1. SPECIFICATIONS

1.1 Features

Item	Standard Value
Display Type	480 * 3(RGB) * 272 Dots
LCD Type	a-Si TFT, Positive/Normally white TN, Transmissive Type
Screen size(inch)	4.3"(Diagonal)
Viouing Direction	6 O'clock (Gray scale Inversion)*1
Viewing Direction	12 O'clock (*2)
Color configuration	R,G,B vertical stripe
Display Interface	Digital 24-bits RGB
Driver IC	ST7282-G4
	THIS PRODUCT CONFORMS THE ROHS OF PTC
ROHS	Detail information please refer website :
	http://www.powertip.com.tw/news.php?area_id_view=1085560481/

^{*1.} For saturated color display content (e.g. pure-red, pure-green, pure-blue or pure-colors -combinations).

1.2 Mechanical Specifications

-				
	Item	Standard Value	Unit	
	Outline Dimension	115.1 (W) x 78.94 (L) x 4.8 (H)	mm	

LCD panel

Item	Standard Value		
Active Area	95.04 (W) x 53.85 (L)	mm	
Pixel Size	0.198 (W) * 0.198 (H)	mm	

Note: For detailed information please refer to LCM drawing

^{*2. &}quot;For display content based upon multicolor images e.g. photos, RGB defined user interfaces".



1.3 Absolute Maximum Ratings

Module

Item	Symbol	Condition	Min.	Max.	Unit
System Power Supply Voltage	V_{DD}	GND=0	-0.3	+4.6	٧
Input Voltage Range	Vin	-	-0.3	V _{DD} +0.3	V
Operating Temperature	Тор	-	-20	+70	°C
Storage Temperature	T _{ST}	- (-30	+80	°C
Storage Humidity	H _D	Ta ≤ 60°C	10	90	%RH

1.4 DC Electrical Characteristics

Module GND = 0V, Ta = 25°C

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Power supply Voltage	V_{DD}	-	3.0	3.3	3.6	V
"H" Input Voltage	VIH		0.7*V _{DD}	-	V_{DD}	V
"L" Input Voltage	VıL	-	GND	-	0.3*V _{DD}	V
"H" Output Voltage	Vон	-	V _{DD} -0.4	-	V_{DD}	V
"L" Output Voltage	Vol	-	GND	-	GND+0.4	V
Supply Current	I_{DD}	V _{DD} =3.3V	-	(35)	(50)	mA



1.5 Optical Characteristics

TFT LCD Panel V_{DD}=3.3V, Ta=25°C

Item		Symbol	Condition	Min.	Тур.	Max.	unit	
Response tin	ne	Tr + Tf	-	-	29	44	ms	Note2
	Тор	θΥ+		-	60	-		
Viewing and	Bottom	θΥ-	CD > 40	-	60	-	Dag	NI-t-4
Viewing angle	Left	θХ-	CR ≥ 10	-	60	-	Deg.	Note4
	Right	θX+		-	60	-		
Contrast rati	0	CR	-	500	600	-	-	-
	White	Х			(0.28)	-		
	vvnite	Y		-	(0.30)	-		
	Red	Х		-	(0.58)	-		
Color of CIE Coordinate	Reu	Υ	IF= 20 mA	-	(0.36)	-		Note1
(With B/L&T/P)	Green	Х	IF = 20 IIIA		(0.32)	-	_	Note i
	Green	Y		-	(0.57)	-		
	Dlug	Х		-	(0.14)	-		
	Blue	Υ		-	(0.05)	-		
Average Brighti	ness							
Pattern=white di	splay	IV	IF= 20 mA	(260)	(280)	-	cd/m ²	Note1
(With LCD&T/F	P) *1							
Uniformity (With LCD&T/F	P) *2	△B	IF= 20mA	70	-	-	%	Note1



Note1:

 $1: \triangle B=B(min) / B(max) \times 100\%$

2: Measurement Condition for Optical Characteristics:

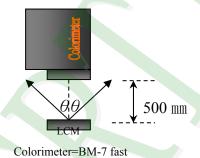
a : Environment: 25°C±5°C / 60±20%R.H , no wind , dark room below 10 Lux at typical lamp current and typical operating frequency.

b : Measurement Distance: 500 \pm 50 mm \rightarrow (θ = 0°)

c: Equipment: TOPCON BM-7 fast, (field 1°), after 10 minutes operation.

d: The uncertainty of the C.I.E coordinate measurement ±0.01, Average Brightness ± 4%

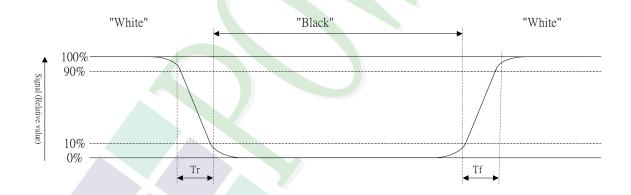




Note2: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white" (falling time) and from "white" to "black" (rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.

Refer to figure as below:



Note3: Definition of contrast ratio:

Contrast ratio is calculated with the following formula

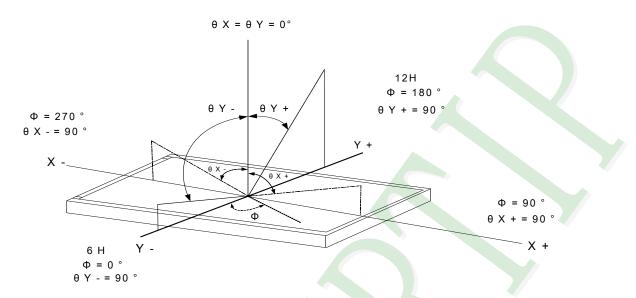
Photo detector output when LCD is at "White" state

Contrast ratio (CR) =

Photo detector output when LCD is at "Black" state



Note4: Definition of viewing angle: Refer to figure as below:





1.6 Backlight Characteristics

Maximum Ratings

Item	Symbol	Conditions	Min.	Max.	Unit
LED Forward Current	IF	Ta =25°ℂ	-	30	mA
LED Reverse Voltage (Each one)	VR	Ta =25°ℂ		5	V
Power Dissipation	PD	Ta =25°ℂ	-	735	mW

Electrical / Optical Characteristics

<u> </u>						
Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage	VF		19.6	22.4	24.5	V
Average Brightness (Without LCD & T/P)	IV	IF=20mA	5500	6000	_	cd/m ²
CIE Color Coordinate	X		0.24	0.27	0.30	
(Without LCD & T/P)	Y		0.24	0.27	0.30	-
Color			White			

^{*1:} The "LED life time" is defined as the module brightness decrease to 50% original brightness at Ta=25°C and I∟=20mA. The LED lifetime could be decreased if operating I∟ is larger than 20 mA.

Internal Circuit Diagram















K

Other Description

Item	Conditions	Description
Life Time*1	Ta =25°ℂ	20,000 hrs
Life Time 1	IF= 20mA	20,000 1113



1.7 Touch Panel Characteristics

Features

Item	Standard Value			
Touch Panel Size	4.3"			
Touch type	Projective capacitive touch panel			
roden type	True Multi-touch with up to 5 Points of Absolution			
Output Interface	I ² C			
IC	FT5426(Focal IC)			

I²C Address

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0	1	1	1	0	0	0	R/W

Bit 0: 0 for Write / 1 for Read

Mechanical Specifications

Item	Standard Value	Unit
Viewing Area	97.10 mm (W) x 55.90 mm (H)	mm
Number of sensing channel	16 (W) x 11 (H)	mm

Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
Supply voltage	VDD	-	-0.3	3.6	٧
Operating Temperature	Тор	-	-20	+70	°C
Storage Temperature	T _{ST}	-	-30	+80	°C

DC Electrical Characteristics

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Power Supply Voltage	VDD	-	2.8	3.3	3.6	٧



I²C Read/Write Interface description

Write N bytes to I2C slave

		5	Sla	ve .	Ado	dr				Da	ta A	\dc	lres	s[2	[]					Ι	Data	a [2	K]					D	ata	[X-	⊦N-	1]			
S	A 6	A 5	. A 4	A 3	A 2	A 1	A 0	R W	A Å	R R	R	R 4	R 3	R 2	R 1	R 0	A	D 7	D 6	D 5	D 4	D 3	D 2	D 1	D 0	A	 D :	D .	D I) [3) D	1	D 0	A	P
START					_			WRITE	ACK	, 0				_			ACK	•					_		•	ACK	•				4		•	ACK	STOP

Set Data Address

		5	Slav	ve 1	Ado	dr]	Dat	a A	Ado	lres	ss[2	X]			
C	A	A	A	Α	A	Α	A	R	Λ	R	R	R	R	R	R	R	R	Λ	D
3	6	5	4	3	2	1	0	W	A	7	6	5	4	3	2	1	0	А	Р
S								V											
STAR								\aleph	A									A	ST
RI								Ξ	\overline{x}									\overline{x}	P
								(*)											

Read X bytes from I2C Slave

			Sla	ve 1	Ad	dr						I	Dat	a []	N]					Ι	Data	a []	X+	N-1	[]			
S	A	A	A	A	A	A	A	R	A							D	D	A	 D	D	D			D		D	A	P
	6	5	4	3	2	1	0	W		1/	6	5	4	3	2	1	0		1	6	2	4	3	2	1	0		
SI]							Re	A									A									AC	ST
K	1							ad	X									X									X	Q

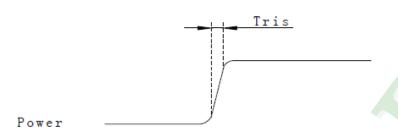
Mnemonics Description

Mnemonics	Description
S	I2C Start or I2C Restart
A[6:0]	Slave address
	A[6:0]:0111000b
R/W	'1' for read, '0'for write
A(N)	ACK(NACK)
Р	STOP: the indication of the end of a packet (if this bit is missing, S will
	indicate the end of the current packet and the beginning of the next
	packet)

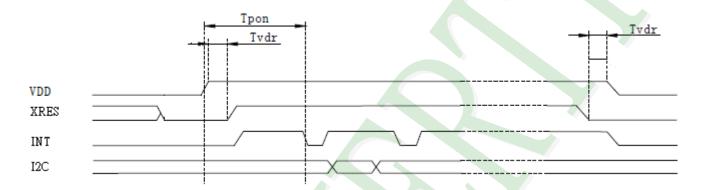
Timing Characteristics

Parameter	Unit	Min	Max
SCL frequency	KHz	0	400
Bus free time between a STOP and START condition	us	4.7	\
Hold time (repeated) START condition	us	4.0	\
Data setup time	ns	250	\
Setup time for a repeated START condition	us	4.7	\
Setup Time for STOP condition	us	4.0	\

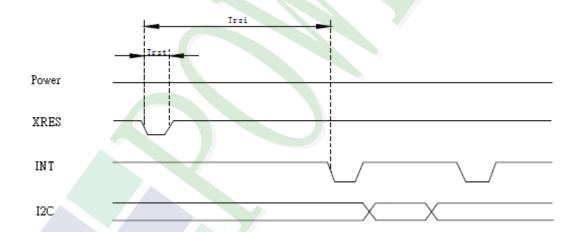




Power on time



Power on Sequence



Reset Sequence

Power on / Reset Sequence Parameters

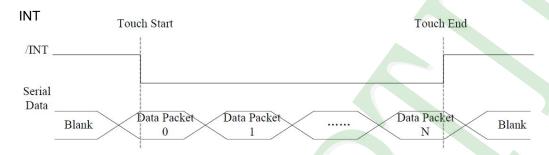
Parameter	Description	Min	Max	Units
Tris	Rise time from 0.1VDD to 0.9VDD		5	ms
Tpon	Time of starting to report point after powering on	200		ms
Tvđr	Reset time after VDD powering on	1		ms
Trsi	Time of starting to report point after resetting	200		ms
Trst	Reset time	1		ms



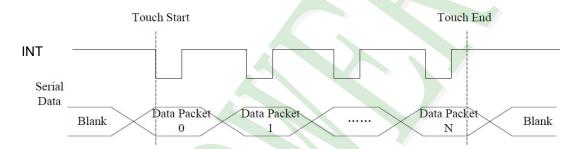
Interrupt signal from CTP to Host

As for standard CTP, host need to use both interrupt control signal and serial data interface to get the touch data. There are two kind of method to use interrupt: interrupt trigger and interrupt query.

Here is the timing to get touch data.



Interrupt query mode



Interrupt trigger mode

Host use general I2C protocol to read the touch data or the information from CTP. CTP will send host a interrupt signal when there is a valid touch. Then host can use the serial data interface to get the touch data. If there is no valid touch detected, the INT will not be pulled up, the host do not need to read the touch data.

NOTE: "valid touch" may have different definition in various systems. For example, in some systems, the valid touch is defined as there is one more valid touch point. But in some other systems, the valid touch is defined as one more valid touch with valid gestures. In usual, INT will be pulled up when there is a valid touch point, and to be low when a touch finishes.

As for interrupt trigger mode, INT signal will be low if there is a touch detected. But for per update of valid touch data, CTP will produce a valid pulse for INT signal, host can read the touch data periodically according to the frequency of this pulse. In this mode, the pulse frequency is the touch data update frequency.



CTP Register Mapping

Address	Name	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	Host Access		
00h	DEVIDE_MODE	-	Device	Mode	[2:0]	-	-	-	-	WR		
01h	TD_STATUS	-	-	-	-	Numb	er of to	ich poin	ts[3:0]	R		
02h	TOUCH1_XH	1st Eve	ent Flag	-	-	1st To	ouch X	Position	[11:8]	R		
03h	TOUCH1_XL			1st To	ouch X	Position	[7:0]			R		
04h	TOUCH1_YH	1	st Touch	ID[3:0]		1st To	ouch Y I	Position	[11:8]	R		
05h	TOUCH1_YL			1st To	ouch Y	Position	[7:0]			R		
06h	-				,	-				R		
07h	-					-				R		
08h	TOUCH2_XH	2st Eve	ent Flag	-	-	2st To	ouch X	Position	[11:8]	R		
09h	TOUCH2_XL			2st To	ouch X	Position	[7:0]			R		
0Ah	TOUCH2_YH	2	st Touch	ID[3:0]		2st To	ouch Y l	Position	[11:8]	R		
0Bh	TOUCH2_YL			2st To	ouch Y	Position	[7:0]			R		
0Ch	-		4			-				R		
0Dh												
0Eh	TOUCH3_XH	3st Eve	ent Flag	-	-	3st T	ouch X	Position	[11:8]	R		
0Fh	TOUCH3_XL			3st To	ouch X	Position	[7:0]			R		
10h	TOUCH3_YH	3	st Touch	ID[3:0]		3st T	ouch Y I	Position	[11:8]	R		
11h	TOUCH3_YL			3st To	ouch Y	Position	[7:0]			R		
12h	-					-				R		
13h	-					_				R		
14h	TOUCH4_XH	4st Eve	ent Flag	-	-	4st To	ouch X	Position	[11:8]	R		
15h	TOUCH4_XL			4st To	ouch X	Position	[7:0]			R		
16h	TOUCH4_YH	4	st Touch	ID[3:0]		4st T	ouch Y I	Position	[11:8]	R		
17h	TOUCH4_YL			4st To	ouch Y	Position	[7:0]			R		
18h	-			,		_				R		
19h	-					_				R		
1Ah	TOUCH5_XH	5st Eve	ent Flag	-	-	5st To	ouch X	Position	[11:8]	R		
1Bh	TOUCH5_XL			5st To	ouch X	Position	[7:0]			R		
1Ch	TOUCH5_YH	5	st Touch	ID[3:0]		5st To	ouch Y I	Position	[11:8]	R		
1Dh	TOUCH5_YL			5st To	ouch Y	Position	[7:0]			R		
1Eh	-					-				R		
1Fh	-					-				R		



DEVICE_MODE

This register is the device mode register, configure it to determine the current mode of the chip.

Address	Bit Address	Register Name	Description					
00h	6 : 1	Dovice Mede [2:0]	000b Work Mode					
00h	6 : 4	Device Mode [2:0]	100b Factory Mode – read raw data					

TD_STATUS

This register is the Touch Data status register.

Address	Bit Address	Register Name	Description
	7:4	Reserved	
01h	3:0	Number of touch	How many points detected.
		points[3:0]	1-5 is valid.

TOUCHn_XH

This register describes MSB of the X coordinate of the nth touch point and the corresponding event flag.

Address	Bit Address	Register Name	Description
	7:6		00b: Put Down
		Event Flag	01b: Put Up
026			10b: Contact
02h			11b: Reserved
	5 : 4		Reserved
3:0		Touch X Position [11:8]	MSB of Touch X Position in pixels

TOUCHn_XL

This register describes LSB of the X coordinate of the nth touch point

Address	Bit Address	Register Name	Description		
03h	7:0	Touch X Position [7:0]	LSB of the Touch X Position in pixels		

TOUCHn YH

This register describes MSB of the Y coordinate of the nth touch point and corresponding touch ID.

Address	Bit Address	Register Name	Description	
04h	7:4	Touch ID[3:0]	Touch ID of Touch Point	
0411	3:0	Touch Y Position [11:8]	MSB of Touch Y Position in pixels	

TOUCHn_YL

This register describes LSB of the Y coordinate of the nth touch point.

Address	Bit Address	Register Name	Description	
05h~	7:0	Touch Y Position[7:0]	LSB of The Touch Y Position in pixels	



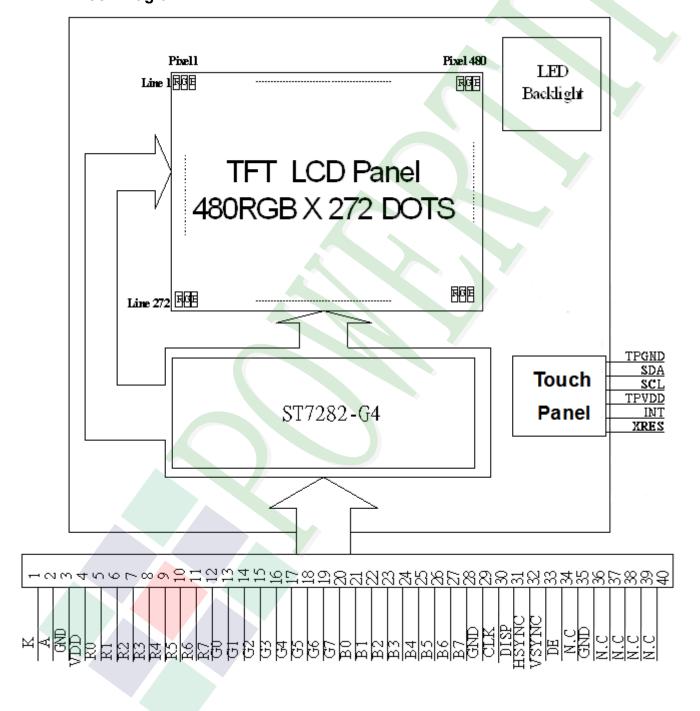
2. MODULE STRUCTURE

2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram

* See Appendix

2.1.2 Block Diagram





2.2 Interface Pin Description

Pin No.	Symbol	Function		
1	K	Power supply for LED Backlight cathode input		
2	А	Power supply for LED Backlight anode input		
3	GND	Ground		
4	V_{DD}	Digital power		
5	R0	Red data bit 0		
6	R1	Red data bit 1		
7	R2	Red data bit 2		
8	R3	Red data bit 3		
9	R4	Red data bit 4		
10	R5	Red data bit 5		
11	R6	Red data bit 6		
12	R7	Red data bit 7		
13	G0	Green data bit 0		
14	G1	Green data bit 1		
15	G2	Green data bit 2		
16	G3	Green data bit 3		
17	G4	Green data bit 4		
18	G5	Green data bit 5		
19	G6	Green data bit 6		
20	G7	Green data bit 7		
21	B0	Blue data bit 0		
22	B1	Blue data bit 1		



Pin No.	Symbol	Function
23	B2	Blue data bit 2
24	В3	Blue data bit 3
25	B4	Blue data bit 4
26	B5	Blue data bit 5
27	B6	Blue data bit 6
28	В7	Blue data bit 7
29	GND	Ground
30	CLK	Dot data clock
31	DISP	Display control / standby mode selection "High": Normal display
32	HSYNC	Horizontal sync input
33	VSYNC	Vertical sync input
34	DE	Data input enable. Active High to enable the data input
35	N.C	Not Connect
36	GND	Ground
37	N.C	Not Connect
38	N.C	Not Connect
39	N.C	Not Connect
40	N.C	Not Connect

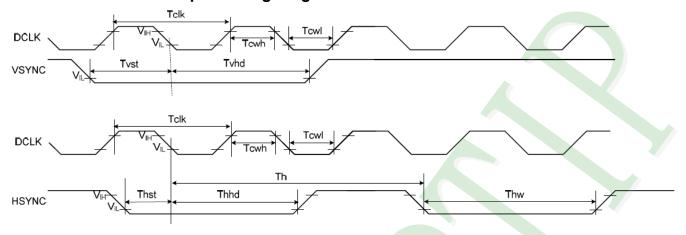
Capacitive Touch Panel (CTP) Interface

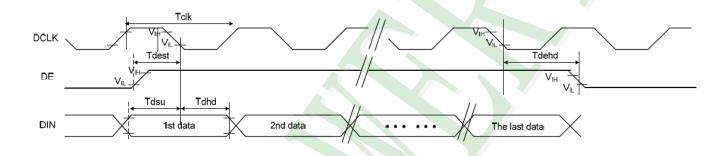
	15 4511 1 41151 (5			
Pin No.	Symbol	Function		
1	TPGND	TP Ground.		
2	SDA	I2C Data		
3	SCL	I2C Clock		
4	TPVDD	TP VDD		
5	INT	Interrupt Output		
6	XRES	Chip Reset Input, Negative Edge Trigger		



2.3 Timing Characteristics

2.3.1 Clock and Data Input Timing Diagram



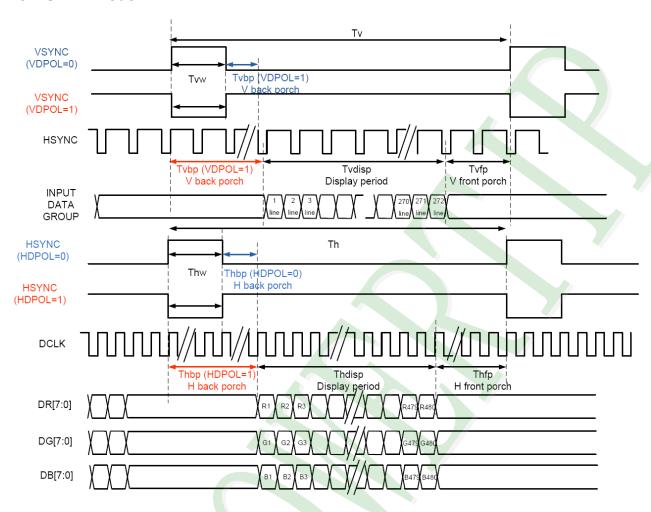




Danamatana	O. was la a l		Spec		1.1:4	O and disting a		
Parameters	ameters Symbol Min. Typ. Max. Unit		Unit	Conditions				
System operation timing								
VDD power source slew time	Tpor	-	-	20	ms	From 0V to 99% VDD		
GRB pulse width	t RSTw	10	50	-	us	R=10Kohm, C=1uF		
	I	nput/ C	Output 1	timing				
CLK pulse duty	Tcw	40	50	60	%	<u>-</u>		
Hsync width	Thw	2	-	-	DCLK	-		
HSYNC period	Th	55	60	65	us	-		
VSYNC setup time	Tvst	12	-	-	ns	-		
VSYNC hold time	Tvhd	12	-	-	ns	-		
HSYNC setup time	Thst	12	-	-	ns	-		
HSYNC hold time	Thhd	12	-		ns	-		
Data setup time	Tdsu	12	-	-	ns	-		
Data hold time	Tdhd	12	-	-	ns	-		
DE setup time	Tdest	10	-	-	ns	-		
DE hold time	Tdehd	10	-	-	ns	-		
SD output stable time	Tst	-	-	12	us	Output settled within +20mV Loading =.6.8k+28.2pF		
GD output rise and fall time	Tgst	-	-	6	us	Output settled (5%~95%), Loading = 4.7k+29.8pF		

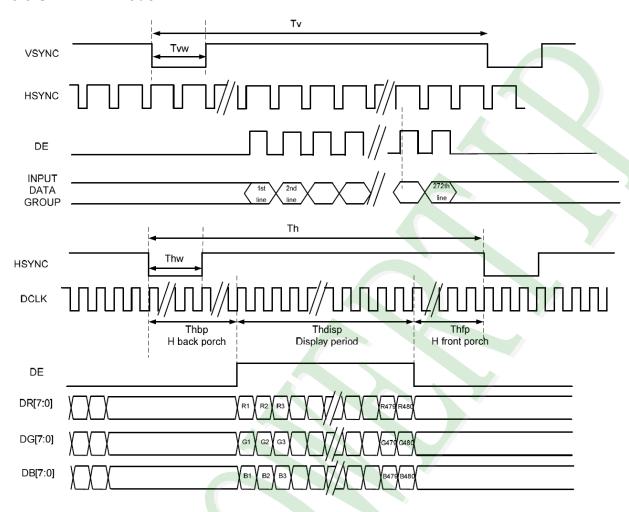


2.3.2 SYNC Mode



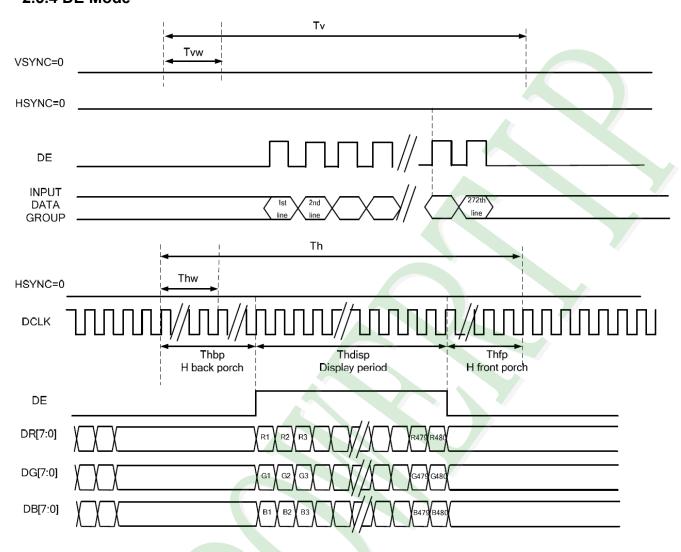


2.3.3 SYNC-DE Mode





2.3.4 DE Mode





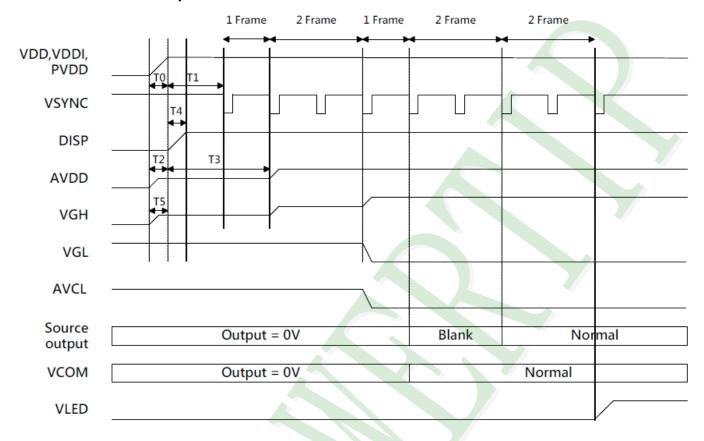
Parallel 24-bit RGB Input Timing Table

Parameters		Cymbol		Unit		
		Symbol	Min.	Тур.	Max.	Offic
DCLK frequency	Fclk	8	9	12	MHz	
DCLK Period		Tclk	83	111	125	nS
	Period Time	Th	485	531	598	DCLK
	Display Period	Thdisp	-	480	-	DCLK
HSYNC	Back Porch	Thbp	3	43	43	DCLK
	Front Porch	Thfp	2	8	75	DCLK
	Pulse Width	Thw	2	4	75	DCLK
	Period Time	Tvdisp	276	292	321	Н
	Display Period	Tvbp	-	272	<u> </u>	Н
VSYNC	Back Porch	Tvfp	2	12	12	Н
	Front Porch	Tvw	2	8	37	Н
	Pulse Width	Tvdisp	2	4	37	Н



2.4 POWER ON/OFF SEQUENCE

2.4.1 Power On Sequence

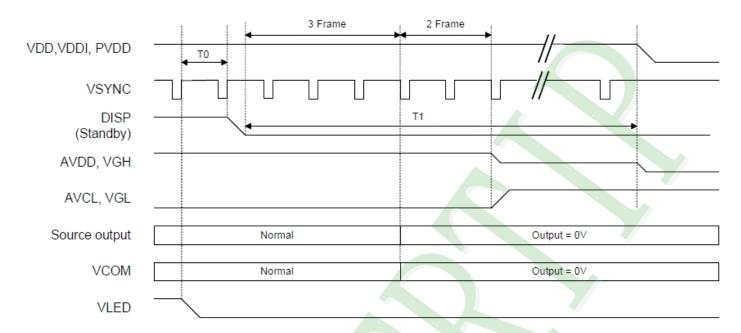


Symbol	Description	Min. Time
T0	Determined by the external power	
T1	Time from stable VDD, VDDI, PVDD set-up to the first VSYNC	T1=0
T2	Time from AVDD=0V to AVDD=3.3V	T2=T0
Т3	me from AVDD=3.3V to AVDD=6.0V	T3=T1+ (1*Frame)
T4	Time from stable VDD, VDDI, PVDD set-up to DISP asserted	T4=0
T5	Time from VGH=0V to VGH=3.3V	T5=T0

Note: Recommend the LCM power on rise time T0= 0~1ms.



2.4.2 Power Off Sequence



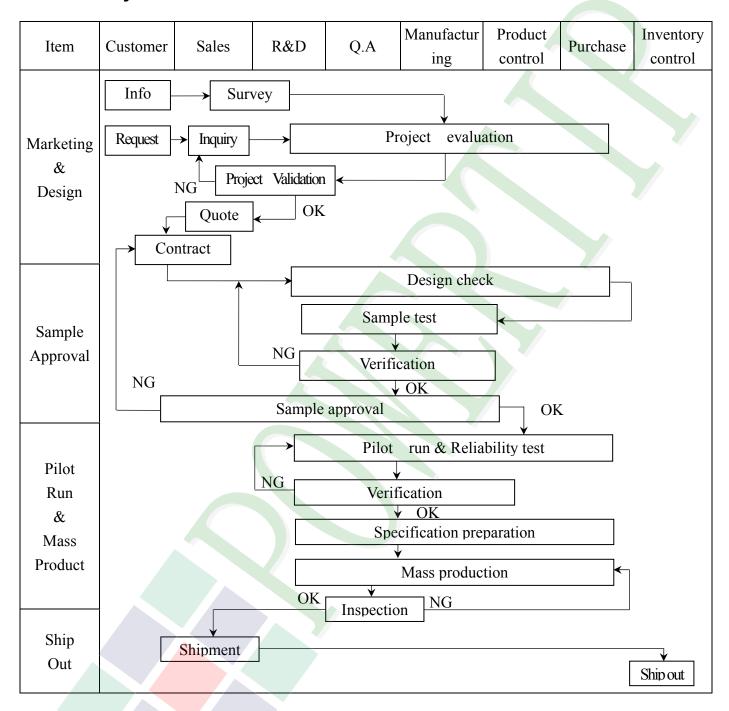
Symbol	Description	Min. Time
T0	Time from backlight power off to DISP="L"	1*Frame
T1	Time from DISP="L" to LCM Power off	5*Frame



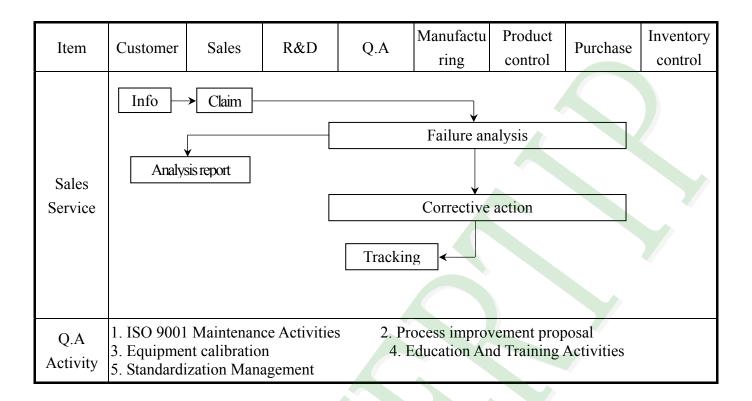


3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart









3.2 Inspection Specification

igspaceScope: The document shall be applied to TFT-LCD Module for 3. 5" ~15" (Ver.B01).

♦ Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level II.

◆Equipment : Gauge · MIL-STD · Powertip Tester · Sample

◆Defect Level: Major Defect AQL: 0.4; Minor Defect AQL: 1.5

♦OUT Going Defect Level: Sampling.

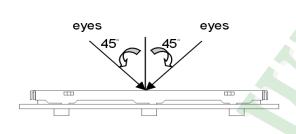
◆Standard of the product appearance test:

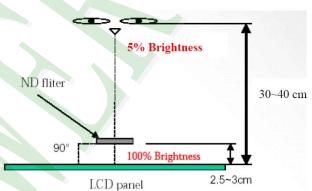
a. Manner of appearance test:

(1). The test best be under 20W×2 fluorescent light(about 300lux ~500lux)

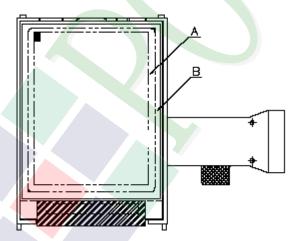
, and distance of view must be at 30~40 cm.

(2). The test direction is base on about around 45° of vertical line.





(3). Definition of area.



A area: viewing area

B area: Outside of viewing area

(4). Standard of inspection: (Unit: mm)



♦Specification For TFT-LCD Module 3. 5″ ~15″:

NO	Item	Criterion				
		1. 1The part number is inconsistent with work order of production.				
01	Product condition	1. 2 Mixed product types.	Major			
		1. 3 Assembled in inverse direction.	Major			
02	Quantity	2. 1The quantity is inconsistent with work order of production.	Major			
03	Outline dimension	3. 1 Product dimension and structure must conform to structure diagram.	Major			
		4. 1 Missing line character and icon.	Major			
		4. 2 No function or no display.	Major			
0.4		4. 3 Display malfunction.	Major			
04	Electrical Testing	4. 4 LCD viewing angle defect.				
		4. 5 Current consumption exceeds product specifications.				
		4. 6 Mura can not be seen through 5% ND filter at 50% Gray screen, should be judged by the viewing angle of 90 degree.	Minor			
		Item Acceptance (Q'ty)				
	Dot defect	Bright Dot ≤ 4				
		Defect Joint Dot ≤ 3				
05	(Bright dot \ Dark dot)	Total ≤ 7	Minor			
00	Dark dot)		14111101			
	On -display	5.1 Inspection pattern: full white, full black, Red, Green and				
		blue screens.				
		5. 2 It is defined as dot defect if defect area >1/2 dot.				
		5. 3 The distance between two dot defect ≥5 mm.				
	5.4 Bright dot that can not be seen through 5% ND filter.					



◆Specification For TFT-LCD Module 3. 5″ ~15″:

→ Spec	CHICACION FOL TE	-LCD MIUU	uic 0. J	10.					(ver.	D01)	
NO	Item	Criterion			Le	evel					
	6. 1 R Black or white dot \(\) scratch \(\) contamination		mensio	Non-displa on (diamete $\Phi \leq 0$. $< \Phi \leq 0$. $\Phi > 0$	r: Φ) 25 50	Acceptal A area Ignore 5	nce (Q'ty) B area Ignore				
	Round type			Total		5					
	Round type $\begin{array}{c c} & X & & \\ & Y & \\ \hline & Y & \\ \end{array}$	6. 2 Line ty	ype(No	on-display o	or displ	ay):					
06	<u>Y</u>	module	e size	Length (L)	W	idth (W)	Acceptanc A area	e (Q'ty) B area	M	inor	
00						W ≤ 0.03	Ignore		1711	11101	
	$\Phi = (x+y)/2$ Line type 3.5°			L ≤10.0	0.03	$<$ W ≤ 0.05	4				
		3 5"	3.5" to l	ogg 022	L ≦ 5.0	0.05	$<$ W ≤ 0.10	2	Ignoro		
		3.3 10 1	less 9		W >0.10 As round	Ignore					
	1						type				
	✓ / ¥ W				Total		5				
	· · · · · · · · · · · · · · · · · · ·					$W \le 0.05$	Ignore				
	L			L ≤10.0	0.05	$<$ W \leq 0.10	5				
		9" to	15"			W >0.10	As round type	Ignore			
					Total		5				
		Dime	ension	(diameter :	Ф) —		nce (Q'ty)				
						A area	Bare	ea			
07	Polarizer Bubble			$\Phi \leq 0.25$		Ignore					
		0	0.25 <	$\Phi \leq 0.50$		4			Mi	ino	
		0	0.50 <	$\Phi \leq 0.80$		1	Igno	re			
				$\Phi > 0.80$	0	0					
			Т	otal		5					



◆Specification For TFT-LCD Module 3. 5″ ~15″:

NO	Item	Criterion		
		Z: The thickness of crack W	: The width of crack. : terminal length LCD side length	
		8. 1 General glass chip: 8. 1. 1 Chip on panel surface and crack	k between panels:	> //
08	The crack of glass	SP Z	Z Y Y SP	Minor
		Y [OK]	[NG]	
		Z.		
		X Y	Z	
		≤ a Crack can't enter viewing area	≦1/2 t	
		≤ a Crack can't exceed the half of SP width.	1/2 t < Z ≤2 t	



◆Specification For TFT-LCD Module 3. 5″~15″:

NO	Item	Criterion					
	Symbols: X: The length of crack Z: The thickness of crack t: The thickness of glass Y: The width of crack W: terminal length a: LCD side length						
		8.1.2 Corner crack:					
		X Y Z					
		≤1/5 a Crack can't enter viewing area $ Z ≤ 1/2 t$					
		$\leq 1/5$ a Crack can't exceed the half of SP width. $1/2$ t $<$ Z ≤ 2 t					
08	The crack of glass		Minor				
00	The crack of glass	8.2 Protrusion over terminal:	WIIIOI				
		8. 2. 1 Chip on electrode pad:					
		W X					
		X Y Z					
		Front $\leq a$ $\leq 1/2 \mathrm{W}$ $\leq t$					
		Back $\leq a$ $\leq W$ $\leq 1/2 t$					



◆Specification For TFT-LCD Module 3. 5″ ~15″:

NO Item Criterion	Level
Symbols: X: The length of crack Y: The Z: The thickness of crack W: tell	ne width of crack. rminal length D side length



◆Specification For TFT-LCD Module 3. 5″~15″:

<u> </u>	cation For 1F1-L		(Ver.BU1)
NO	Item	Criterion	Level
09	Backlight elements	9. 1 Backlight can't work normally.	Major
		9. 2 Backlight doesn't light or color is wrong.	Major
		9. 3 Illumination source flickers when lit.	Major
		10. 1 Pin type \quantity \dimension must match type in structure diagram.	Major
10	10. 2 No short circuits in	10. 2 No short circuits in components on PCB or FPC.	Major
	General	10. 3 Parts on PCB or FPC must be the same as on the production characteristic chart .There should be no wrong parts , missing parts or excess parts.	Major
	appearance	10. 4 Product packaging must the same as specified on packaging specification sheet.	Minor
		10. 5 The folding and peeled off in polarizer are not acceptable.	Minor
		10. 6 The PCB or FPC between B/L assembled distance(PCB or FPC) is ≤1.5 mm.	Minor



4. RELIABILITY TEST

4.1 Reliability Test Condition

(Ver.B01)

NO.	TEST ITEM	TEST CONDITION		
1	High Temperature Storage Test	Keep in +80 ±2°C 240 hrs Surrounding temperature, then storage at normal condition 4hrs.		
2	Low Temperature Storage Test	Keep in −30 ±2°C 240 hrs Surrounding temperature, then st	orage at normal condition 4hrs.	
3	High Temperature / High Humidity Storage Test	Keep in +60 °C / 90% R.H duration for 240 hrs Surrounding temperature, then storage at normal condition 4hrs. (Excluding the polarizer)		
4	Temperature Cycling Storage Test	$-30^{\circ}\text{C} \rightarrow +25^{\circ}\text{C} \rightarrow +80^{\circ}\text{C} \rightarrow +25^{\circ}\text{C}$ $(30\text{mins}) (5\text{mins}) (5\text{mins})$ 20 Cycle Surrounding temperature, then storage at normal condition 4hrs.		
5	ESD Test	Air Discharge: Apply 2 KV with 5 times Discharge for each polarity +/- 1. Temperature ambiance: 15°C ~35°C 2. Humidity relative: 30% ~60% 3. Energy Storage Capacitance(Cs+Cd): 150pF±10% 4. Discharge Resistance(Rd): 330 Ω±10% 5. Discharge, mode of operation: Single Discharge (time between successive discharges at least 1 sec) (Tolerance if the output voltage indication: ±5%)		
6	Vibration Test (Packaged)	 Sine wave 10~55 Hz frequency (1 min/sweep) The amplitude of vibration :1.5 mm Each direction (X \ Y \ Z) duration for 2 Hrs 		
7	Drop Test (Packaged)	Packing Weight (Kg	122 76 61 46	

OResult Evaluation Criteria:

Under the display quality test conditions with normal operations with normal operation state. Do not change these conditions as such changes may affect practical display function. (Normal operation state)

Temperature: +20~30°C Humidity: 50~70%

Atmospheric pressure: 86~106Kpa



5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

5.2 HANDLING

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—when working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So, please handle it very carefully, do not touch, push or rub the exposed polarizing with anything harder than an HB pencil lead (glass, tweezers, etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is 320±10°C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM.
- 5.2.10 Caution! (LCM products with Capacitive Touch Panel)
 Strong EMI-sources such as switch-mode power supplies (SMPS) can lead to touch malfunction (e.g. ghost-touches).

Therefore, the touch needs to be thoroughly tested inside the target application.

5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is 25° C $\pm 5^{\circ}$ C and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

5.4 TERMS OF WARRANTY

5.4.1 Applicable warrant period

The period is within thirteen months since the date of shipping out under normal using and storage conditions.

5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.

